

TOSHIBA RF POWER AMPLIFIER MODULE

S-AU99H

UHF Band FM Power Amplifier Module
Hand-Held Transceiver

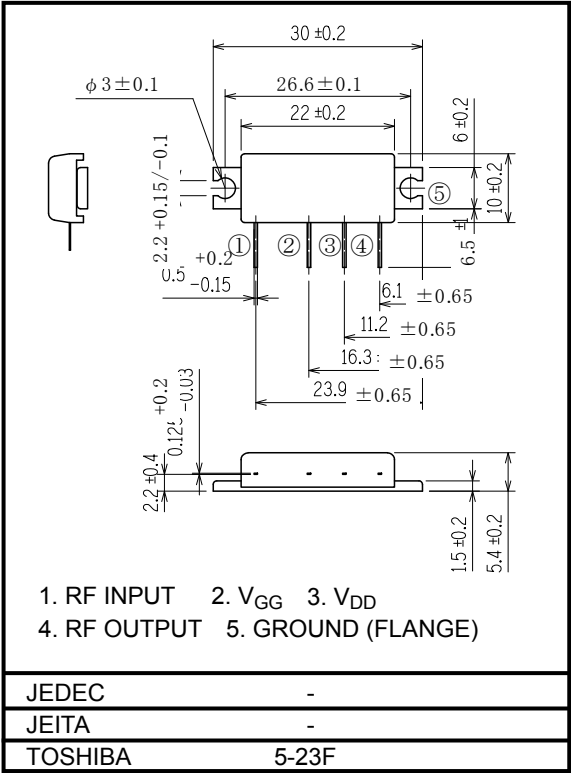
Absolute Maximum Ratings (Tc = 25°C, IT < 3 A, ZG = ZL = 50 Ω)

CHARACTERISTICS	SYMBOL	TEST CONDITION	RATING	UNIT
Maximum Current	IT		3	A
Power Supply Voltage	VDD	VGG = 0 V (GND), RF: none	17	V
Control Voltage	VGG	7.2V < Vdd < 13.2 V, Pi=20 mW	6	V
Output Power	Pomax	7.2V < Vdd < 13.2 V, Vgg < 4 V, Pi = 20 mW	10	W
Input Power	Pi	7.2V < Vdd < 13.2 V, Vgg < 4 V	30	mW
Operating Case Temperature	Tc (opr)	7.2V < Vdd < 13.2 V, Vgg < 4V, Pi = 20 mW	-30 to 90	°C
Storage Temperature	Tstg		-40 to 110	°C

- Note 1: The maximum ratings are the limits that must not be exceeded even for an instant, under worst possible conditions. Exceeding the ratings may cause device damage, ignition, or deterioration. Therefore, when designing the circuitry, derating factors should be applied so that the absolute maximum ratings are not exceeded.
- Note 2: The case temperature is monitored using the screw terminal blocks on the input side that are used for the module implementation.
- Note 3: To protect a device from being permanently damaged, the power-on sequence must be as follows (, while the reversed order should be applied when turning off): 1. VDD, 2. Pi, 3. VGG

Package Outline

Unit: mm



Weight: 3.5g (typ.)

Electrical Characteristics (T_c = 25°C, Z_G = 50 Ω)

CHARACTERISTICS	SYMBOL	TEST CONDITION	MIN	TYP.	MAX	UNIT
Frequency Range	f _{range}	—	450	—	520	MHz
Output Power	P _O	V _{DD} = 9.6 V, V _{GG} = 4 V, P _i = 20 mW, Z _L = 50 Ω	7	—	—	W
Total Efficiency	η _T		45	—	—	%
Input VSWR	VSWR _{in}	P _O =7W, V _{DD} = 9.6 V, V _{GG} = adjust, P _i = 20 mW, Z _L = 50 Ω	—	—	3.0	—
Second Harmonic	2nd HRM		—	—	-25	dB
Ruggedness	—	V _{DD} = 13.2V, 0 V ≤ V _{GG} ≤ V _{GGaj} s (V _{GG} = V _{GGaj} s @ P _O = 7.5 W) P _i = 20 mW P _O = 7.5 W (Adjusted via V _{GG} @ Z _L = 50Ω) VSWR LOAD 20: 1 ALL PHASE (@ 2 s)	No Damage			—
Stability	—	7.2 V ≤ V _{DD} ≤ 13.2 V, 0 V ≤ V _{GG} ≤ V _{GGaj} s (V _{GG} = V _{GGaj} s @ P _O = 7.5 W) P _i = 20 mW P _O ≤ 7.5 W (Adjusted via V _{GG} @ Z _L = 50Ω) VSWR LOAD 3: 1 ALL PHASE	No spurious output of -60 dB or greater			—

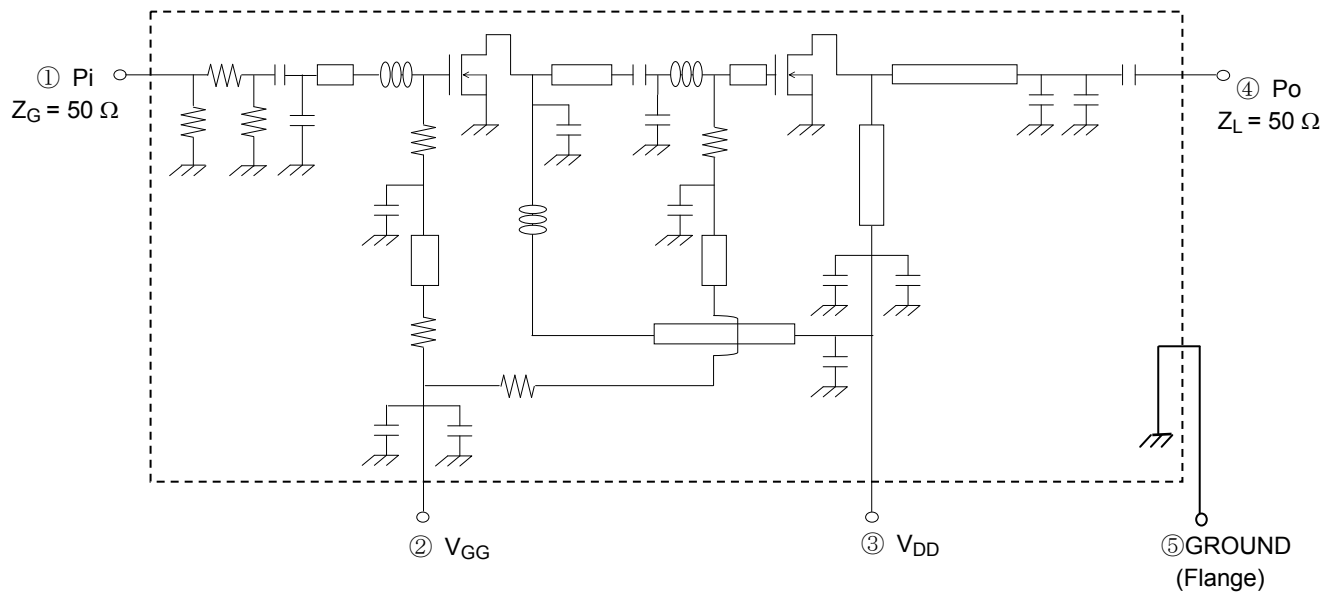
Note 4: Stability

Measurements are performed under the conditions where VSWR is at 3:1 through all phases over the whole frequency range, and they are guaranteed only under those conditions. Even though it is guaranteed to be stable where VSWR is at 3:1, the VSWR load over the operating frequency should be designed to be 50 Ω. At the same time, ensure that the VSWR load does not deviate much from 50 Ω even for a moment, nor deviate even a little from 50 Ω continually. The S-AU99H is not intended for such operations, and proper operation under such conditions is not guaranteed due to the possibilities of heat generation in the module and its applications.

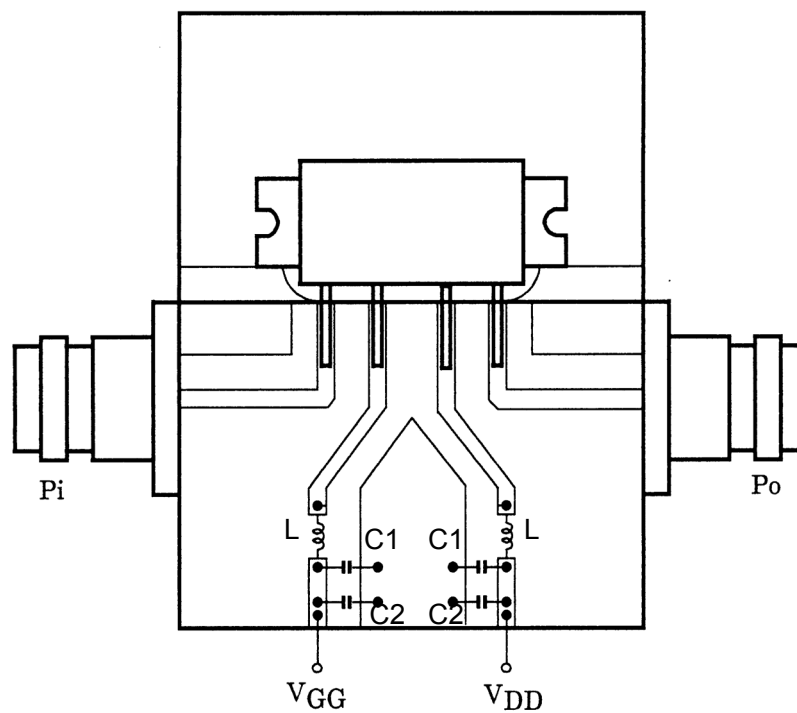
Handling Precautions

- Since this product has a protective cap, care should be taken to avoid applying an excessive impact and allowing foreign objects to get inside when handling this product. Also, please do not remove a cap. If the cap is removed, the foreign object inside the module or the applied impact may lead IC failure, causing smoke or ignition.
- Since this product is structurally susceptible to static electricity, protections against the static electricity should be applied to objects that may come in direct contact with devices, such as worktables, equipment, operators and solder irons.
- This product is not designed nor intended to perform a continuous transmission for applications like a base station. Please do not use this product for such applications, for the reliability cannot be guaranteed.
- This product is intended to be used for a single operation (single-device operation). A proper operation is not guaranteed for a parallel operation. A parallel operation should be performed in accordance with your own good judgment.
- Mounting method
 - The flatness of a heat sink must not exceed 50 μm. If the flatness exceeds 50 μm, the device may experience an unexpected stress that may lead to module breakdown due to damage or ignition in the substrate inside a module and other module parts.
 - Please apply thermal compound between a module and a heat sink to improve the adhesive property.
 - Use a 3-mm diameter screw with the clamping screw torque of 0.4 to 0.6 Nm.
 - Please solder the module leads after the screw is clamped.

Equivalent Circuit

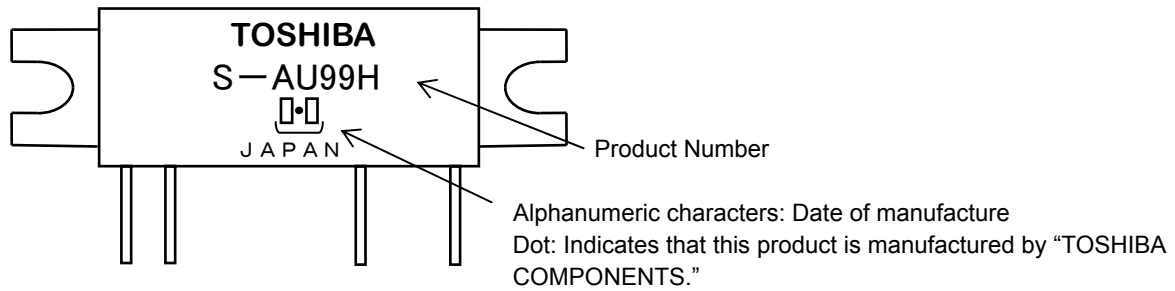


Test Fixture

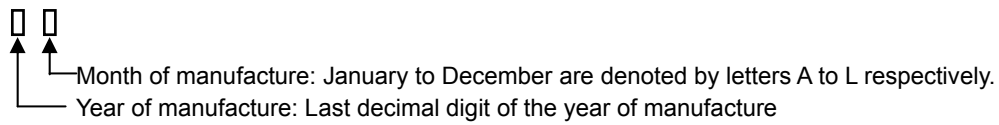


C1 : 10000 pF
 C2 : 10 μ F
 L : ϕ 0.8 ENAMEL WIRE 8T 5ID

Marking



Explanation of Lot No.



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